

Specification for Approval

DEVICE NUMBER: BPI-3C2-15

CUSTOMER:

SAMPLES ATTACHED AREA

PAGE DATE	1	2	3	4	5	6			CONTENTS
2015/1/26	1.0	1.0	1.0	1.0	1.0	1.0			Initial Released

FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

佰鴻工業股份有限公司 BRIGHT LED ELECTRONICS CORP. 新北市板橋區和平路 19 號 3 樓 3F., No.19, He Ping Road, Ban Qiao Dist., New Taipei City, Taiwan

Tel: +886-2-29591090

Fax: +886-2-29547006/29558809

www.brtled.com

ISSUED	APPROVED	PREPARED			
	張孝嚴	莫銳明			

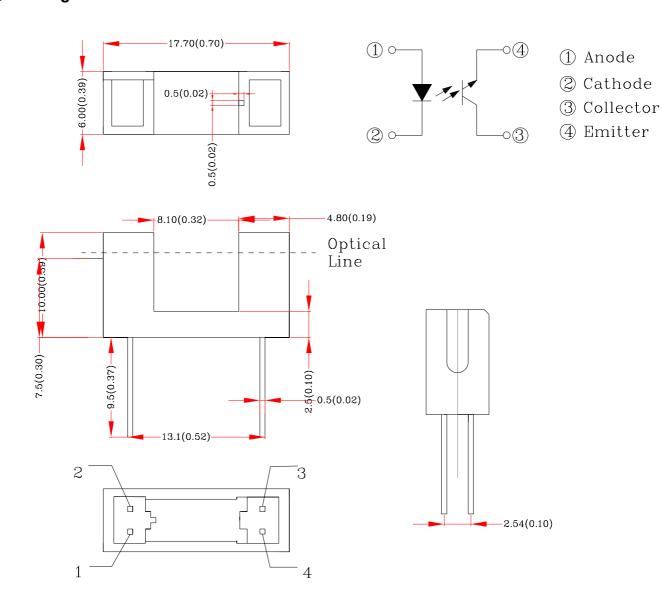


BPI-3C2-15

Features:

- * Non-contact switching.
- * For direct pc board or dual-in-line socket mounting.
- * Fast switching speed.
- *This product doesn't contain restriction substance, comply RoHS standard.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.



BPI-3C2-15

■ Absolute Maximum Rating (Ta=25°C)

Item		Symbol	Rating	Unit	
lanut	Power Dissipation	Pd	75	mW	
	Reverse Voltage	V _R	5	V	
Input	Forward Current	I _F	50	mA	
	Peak Forward Current (*1)	I _{FP}	1	Α	
	Collector Power Dissipation	Pc	100	mW	
Output	Collector Current	I _C	20	mA	
	C-E Voltage	V _{CEO}	30	V	
	E-C Voltage	V _{ECO}	5	V	
Operating Temperature		Topr	-40 ~ +85	$^{\circ}$ C	
Storage Ter	Storage Temperature		-45 ~ +85	$^{\circ}$ C	
Soldering Temperature (*2)		Tsol	260	$^{\circ}\! \mathbb{C}$	

(*1) tw=100 uSec. \ T=10 mSec.

(*2) t=5 Sec

● Electrical Optical Characteristics (Ta=25°C)

Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Bin No.
Input	Forward Voltage	V _F	I _F =20mA	_	1.2	1.5	V	
	Reverse Current	I _R	V _R =5V			100	μ A	
	Peak Wavelength	λр	I _F =10mA		940		nm	
Output	Dark Current	I _D	V _{CE} =5V	_	_	0.5	uA	
	C-E Saturation Voltage	V _{CE(sat)}	$I_C=0.25$ mA $I_F=10$ mA	_	_	0.4	V	
Light Current		Ι _L	V _{CE} =5V I _F =20mA	1.0	_	10.0	mA	
Speed	Rise Time	Tr	$\begin{array}{c} \text{I}_{\text{FP}}\text{=}20\text{mA} \\ \text{V}_{\text{CE}}\text{=}5\text{V} \\ \text{R}_{\text{L}}\text{=}1000\Omega \end{array}$	_	20	_	$\mu\mathrm{sec}$	
	Fall Time	Tf		—	20	_		



BPI-3C2-15

■ Typical Electrical / Optical Characteristics Curves (Ta=2°C)

Fig.1 Power Dissipation vs.
Ambient Temperature

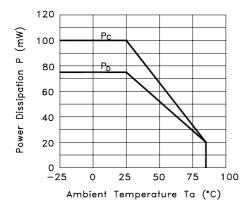


Fig.3 Collector Current vs.
Collector-emitter Voltage

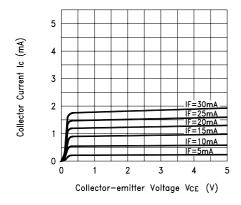


Fig.2 Forward Current vs. Forward Voltage

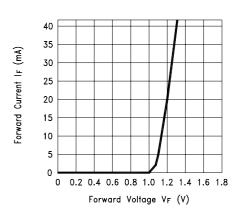
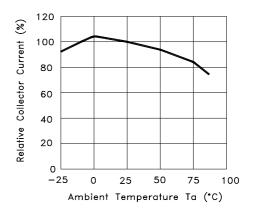


Fig.4 Collector Current vs.
Ambient Temperature

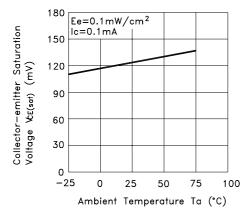




BPI-3C2-15

■ Typical Electrical / Optical Characteristics Curves (Ta=25°C)

Fig.5 Collector—emitter Saturation Voltage vs. Ambient Temperature



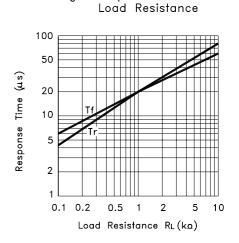
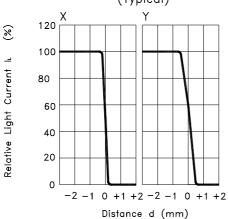
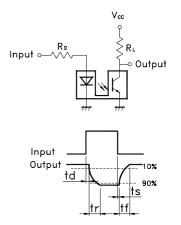


Fig.6 Response Time vs.

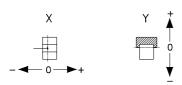
Fig.7 Sensing Position Characteristics (Typical)



Test Circuit for Response Time

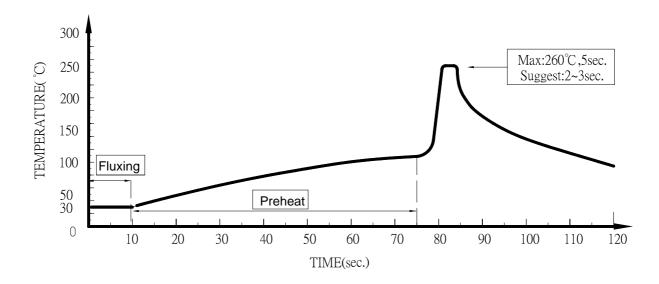


(Center of Optical axis)



BPI-3C2-15

Dip Soldering



- Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- Although the soldering condition is recommended above,soldering at the lowest possible temperature is feasible for the LEDs

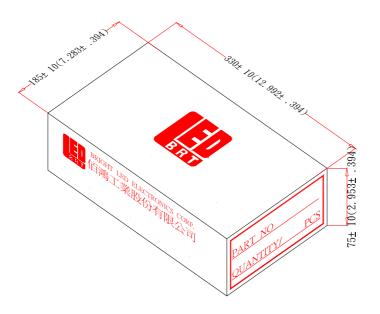
IRON Soldering

300°C Within 3 sec., One time only.

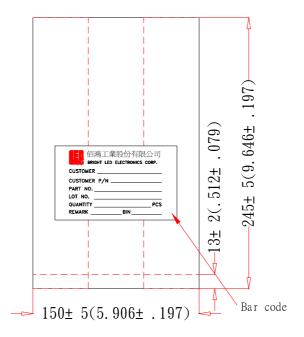


BPI-3C2-15

Packaging Box Dimensions



Packaging Bag Dimensions



Notes:

- 1. 500pcs per bag, 2000pcs per box..
- 2. All Dimensions are in millimeters (inches).
- 3. Specifications are subject to change without notice.